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## FDD86580-F085

## N-Channel PowerTrench ${ }^{\circledR}$ MOSFET

60 V, 50 A, $10 \mathrm{~m} \Omega$

## Features

- Typical $\mathrm{R}_{\mathrm{DS}(o n)}=7.8 \mathrm{~m} \Omega$ at $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=50 \mathrm{~A}$
- Typical $\mathrm{Q}_{\mathrm{g} \text { (tot) }}=20 \mathrm{nC}$ at $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=50 \mathrm{~A}$
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101


## Applications

- Automotive Engine Control
- PowerTrain Management

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- Integrated Starter/Alternator
- Distributed Power Architectures and VRM
- Primary Switch for 12 V Systems

MOSFET Maximum Ratings $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ unless otherwise noted.

| Symbol | Parameter |  | Ratings | Units |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {DSS }}$ | Drain-to-Source Voltage |  | 60 | V |
| $\mathrm{V}_{G S}$ | Gate-to-Source Voltage |  | $\pm 20$ | V |
| ${ }_{\text {I }}$ | Drain Current - Continuous (VGS=10) (Note 1) | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 50 | A |
|  | Pulsed Drain Current | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | See Figure 4 |  |
| $\mathrm{E}_{\text {AS }}$ | Single Pulse Avalanche Energy | (Note 2) | 24 | mJ |
| $\mathrm{P}_{\mathrm{D}}$ | Power Dissipation |  | 75 | W |
|  | Derate Above $25^{\circ} \mathrm{C}$ |  | 0.5 | W/ ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{J},} \mathrm{T}_{\text {STG }}$ | Operating and Storage Temperature |  | -55 to +175 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{R}_{\text {日JC }}$ | Thermal Resistance, Junction to Case |  | 2.0 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\text {日JA }}$ | Maximum Thermal Resistance, Junction to Ambient | (Note 3) | 52 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

Notes:
1: Current is limited by bondwire configuration.
2: Starting $\mathrm{T}_{J}=25^{\circ} \mathrm{C}, \mathrm{L}=30 \mu \mathrm{H}, \mathrm{I}_{\mathrm{AS}}=40 \mathrm{~A}, \mathrm{~V}_{\mathrm{DD}}=60 \mathrm{~V}$ during inductor charging and $\mathrm{V}_{\mathrm{DD}}=0 \mathrm{~V}$ during time in avalanche.
3: $R_{\theta J A}$ is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta J C}$ is guaranteed by design, while $R_{\theta J A}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in $^{2}$ pad of 2 zz copper.

## Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
| :---: | :---: | :---: | :---: | :---: | :---: |
| FDD86580 | FDD86580-F085 | D-PAK(TO-252) | $13 "$ | 16 mm | 2500 units |

Electrical Characteristics $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ unless otherwise noted.

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Off Characteristics

| B VDSs | Drain-to-Source Breakdown Voltage | $\mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  | 60 | - | - | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Idss | Drain-to-Source Leakage Current | $\mathrm{V}_{\mathrm{DS}}=60 \mathrm{~V}$, | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ | - | - | 1 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{G S}=0 \mathrm{~V}$ | $\mathrm{T}_{\mathrm{J}}=175^{\circ} \mathrm{C}$ (Note 4) | - | - | 1 | mA |
| IGSS | Gate-to-Source Leakage Current | $\mathrm{V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}$ |  | - | - | $\pm 100$ | nA |

## On Characteristics

| $\mathrm{V}_{\mathrm{GS}(\mathrm{th})}$ | Gate to Source Threshold Voltage | $\mathrm{V}_{\mathrm{GS}}=\mathrm{V}_{\mathrm{DS}}$ | $=250 \mu \mathrm{~A}$ | 2.0 | 3.6 | 4.2 | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{R}_{\mathrm{DS} \text { (on) }}$ | Drain to Source On Resistance | $\begin{aligned} & I_{D}=50 \mathrm{~A}, \\ & V_{G S}=10 \mathrm{~V} \end{aligned}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ | - | 7.8 | 10 | $\mathrm{m} \Omega$ |
|  |  |  | $\mathrm{T}_{\mathrm{J}}=175^{\circ} \mathrm{C}$ (Note 4) | - | 15.2 | 19 | $\mathrm{m} \Omega$ |

## Dynamic Characteristics

| $\mathrm{C}_{\text {iss }}$ | Input Capacitance | $\begin{aligned} & V_{D S}=30 \mathrm{~V}, V_{G S}=0 \mathrm{~V}, \\ & f=1 \mathrm{MHz} \end{aligned}$ |  | - | 1430 | - | pF |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Coss | Output Capacitance |  |  | - | 440 | - | pF |
| $\mathrm{C}_{\text {rss }}$ | Reverse Transfer Capacitance |  |  | - | 25 | - | pF |
| $\mathrm{R}_{\mathrm{g}}$ | Gate Resistance | $\mathrm{V}_{\mathrm{GS}}=0.5 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  | - | 1.8 | - | $\Omega$ |
| $\mathrm{Q}_{\mathrm{g} \text { (ToT) }}$ | Total Gate Charge | $\mathrm{V}_{\mathrm{GS}}=0$ to 10 V | $\begin{aligned} & V_{D D}=30 V \\ & I_{D}=50 A \end{aligned}$ | - | 20 | 30 | nC |
| $Q_{g(t h)}$ | Threshold Gate Charge | $\mathrm{V}_{\mathrm{GS}}=0$ to 2 V |  | - | 3 | - | nC |
| $\mathrm{Q}_{\mathrm{gs}}$ | Gate-to-Source Gate Charge |  |  | - | 9 | - | nC |
| $Q_{\text {gd }}$ | Gate-to-Drain "Miller" Charge |  |  | - | 4 | - | nC |

## Switching Characteristics

| $\mathrm{t}_{\text {on }}$ | Turn-On Time | $\begin{aligned} & V_{D D}=30 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=50 \mathrm{~A}, \\ & \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{R}_{\mathrm{GEN}}=6 \Omega \end{aligned}$ | - | - | 34 | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{d} \text { (on) }}$ | Turn-On Delay |  | - | 12 | - | ns |
| $\mathrm{t}_{\mathrm{r}}$ | Rise Time |  | - | 11 | - | ns |
| $\mathrm{t}_{\mathrm{d} \text { (off) }}$ | Turn-Off Delay |  | - | 15 | - | ns |
| $\mathrm{t}_{\mathrm{f}}$ | Fall Time |  | - | 5 | - | ns |
| $\mathrm{t}_{\text {off }}$ | Turn-Off Time |  | - | - | 30 | ns |

Drain-Source Diode Characteristics

| $\mathrm{V}_{\mathrm{SD}}$ | Source-to-Drain Diode Voltage | $\mathrm{I}_{\mathrm{SD}}=50 \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ | - | - | 1.25 | V |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{I}_{\mathrm{SD}}=25 \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ | - | - | 1.2 | V |
| $\mathrm{t}_{\mathrm{rr}}$ | Reverse-Recovery Time | $\mathrm{V}_{\mathrm{DD}}=48 \mathrm{~V}, \mathrm{I}_{\mathrm{F}}=50 \mathrm{~A}$, | - | 41 | 61 | ns |
| $\mathrm{Q}_{\mathrm{rr}}$ | Reverse-Recovery Charge | $\mathrm{dl}_{\mathrm{SD}} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}$ | - | 30 | 45 | nC |

Note:
4: The maximum value is specified by design at $\mathrm{T}_{J}=175^{\circ} \mathrm{C}$. Product is not tested to this condition in production.


Typical Characteristics


Figure 5. Forward Bias Safe Operating Area


Figure 7. Transfer Characteristics


Figure 9. Saturation Characteristics


NOTE: Refer to ON Semiconductor Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching Capability


Figure 8. Forward Diode Characteristics


Figure 10. Saturation Characteristics

## Typical Characteristics



Figure 11. $\mathrm{R}_{\text {DSoN }}$ vs. Gate Voltage


Figure 13. Normalized Gate Threshold Voltage vs. Temperature


Figure 15. Capacitance vs. Drain to Source Voltage


Figure 12. Normalized R $_{\text {DSON }}$ vs. Junction Temperature


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature


Figure 16. Gate Charge vs. Gate to Source Voltage


#### Abstract

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